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U.S. DEPARTMENT OF COMMERCE
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To the Director of the U.S. Patent

103496917

ad documents or the new address(es) below.

1. Name of conveying party(ies):

Akane Sano (02/27/2008), Masaaki Tsuruta
(02/29/2008), Nozomu Ozaki (03/03/2008),
Masamichi Asukai (02/27/2008),

Additional name(s) of conveying party(ies) attached? ☒ Yes ☐ No

2. Name and address of receiving party(ies)

Name: Sony Corporation

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Street Address:

1-7-1 Konan, Minato-ku
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JAPAN

City:

State:

Country: Zip:

Additional name(s) & address(es) attached: ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): In parentheses after inventor name

☒ Assignment ☐ Merger ☐ Change of Name

☐ Security Agreement ☐ Joint Research Agreement

☐ Government Interest Assignment

☐ Executive Order 9424, Confirmatory License

☐ Other

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

This application

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Randy J. Pritzker
WOLF, GREENFIELD & SACKS, P.C.

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6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

☐ Authorized to be charged by credit card

☐ Authorized to be charged to deposit account

☒ Enclosed

☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers

Expiration Date

b. Deposit Account Number

Authorized User Name

9. Signature:

Randy J. Pritzker
Signature

4-7-08
Date

Randy J. Pritzker - 35,986

Name of Person Signing

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4/7/08

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RECORDATION FORM COVER SHEET
(continued)

Additional Conveying Party(ies)/Execution Date(s) (1. Continued):

Taiji Ito (02/27/2008), Akinobu Sugino (02/27/2008), Hidehiko Sekizawa (03/04/2008), Yoichiro Sako (02/27/2008), and Hideko Tabata (03/03/2008)

Additional Assignees (2. Continued):

Assignee Name: _____

Internal Address: _____

Street Address: _____

City: _____ State: _____ Country: _____ Zip: _____

Assignee Name: _____

Internal Address: _____

Street Address: _____

City: _____ State: _____ Country: _____ Zip: _____

Assignee Name: _____

Internal Address: _____

Street Address: _____

City: _____ State: _____ Country: _____ Zip: _____

Additional Applications and/or Patents (4. Continued):

Additional Patent Application Numbers
4A. Continued:

Additional Patent Numbers
4B. Continued:

Additional numbers attached?

☐

Yes

☐

No

Docket Number: _____

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements IMAGE STORAGE PROCESSING APPARATUS, IMAGE SEARCH APPARATUS, IMAGE STORAGE PROCESSING METHOD, IMAGE SEARCH METHOD AND PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all present and/or future rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or security interests in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of the said ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me, and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, and applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful documents and papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissues or renewals of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require, and to prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into by me which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date in this application in the spaces that follow: Serial Number: _____, Filing Date: _____.

This assignment executed on the dates indicated below.

Akane SANO

Name of first or sole inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of first or sole inventor

Akane Sano
Signature of first or sole inventor

February 27, 2008
Date of this assignment

Masaaki TSURUTA

Name of second inventor

Tokyo, Japan

Execution date of U.S. Patent Application

Residence of second inventor

*Masaaki Tsuruta**February 29, 2008*

Signature of second inventor

Date of this assignment

Nozomu OZAKI

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Execution date of U.S. Patent Application

Residence of third inventor

*Nozomu Ozaki**March 3, 2008*

Signature of third inventor

Date of this assignment

Masamichi ASUKAI

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Execution date of U.S. Patent Application

Residence of fourth inventor

*Masamichi Asukai**February 27, 2008*

Signature of fourth inventor

Date of this assignment

Taiji ITO

Name of fifth inventor

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Execution date of U.S. Patent Application

Residence of fifth inventor

*Taiji Ito**February 27, 2008*

Signature of fifth inventor

Date of this assignment

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Name of sixth inventor

Execution date of U.S. Patent Applicati

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February 27, 2008

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Hidehiko SEKIZAWA

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Execution date of U.S. Patent Applicati

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Signature of seventh inventor

March 4, 2008

Date of this assignme

Yoichiro SAKO

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Execution date of U.S. Patent Applicati

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Yoichiro Sako

Signature of eighth inventor

February 27, 2008

Date of this assignme

Hideko TABATA

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Execution date of U.S. Patent Applicati

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Hideko Tabata

Signature of ninth inventor

March 3, 2008

Date of this assignmer

PATENT

RECORDED: 04/07/2008

REEL: 020822 FRAME: 0363